VRW0;< ṂṂÞ QSQ ÆṀч s Ⅱㄱ Silicon NPN transistor in a SOT-89 Plastic Package.

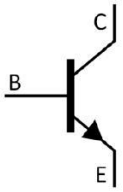
лъ 5VE97<WD Йį´

Complementary pair with 2SB649TA.

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Low frequency power amplifier.

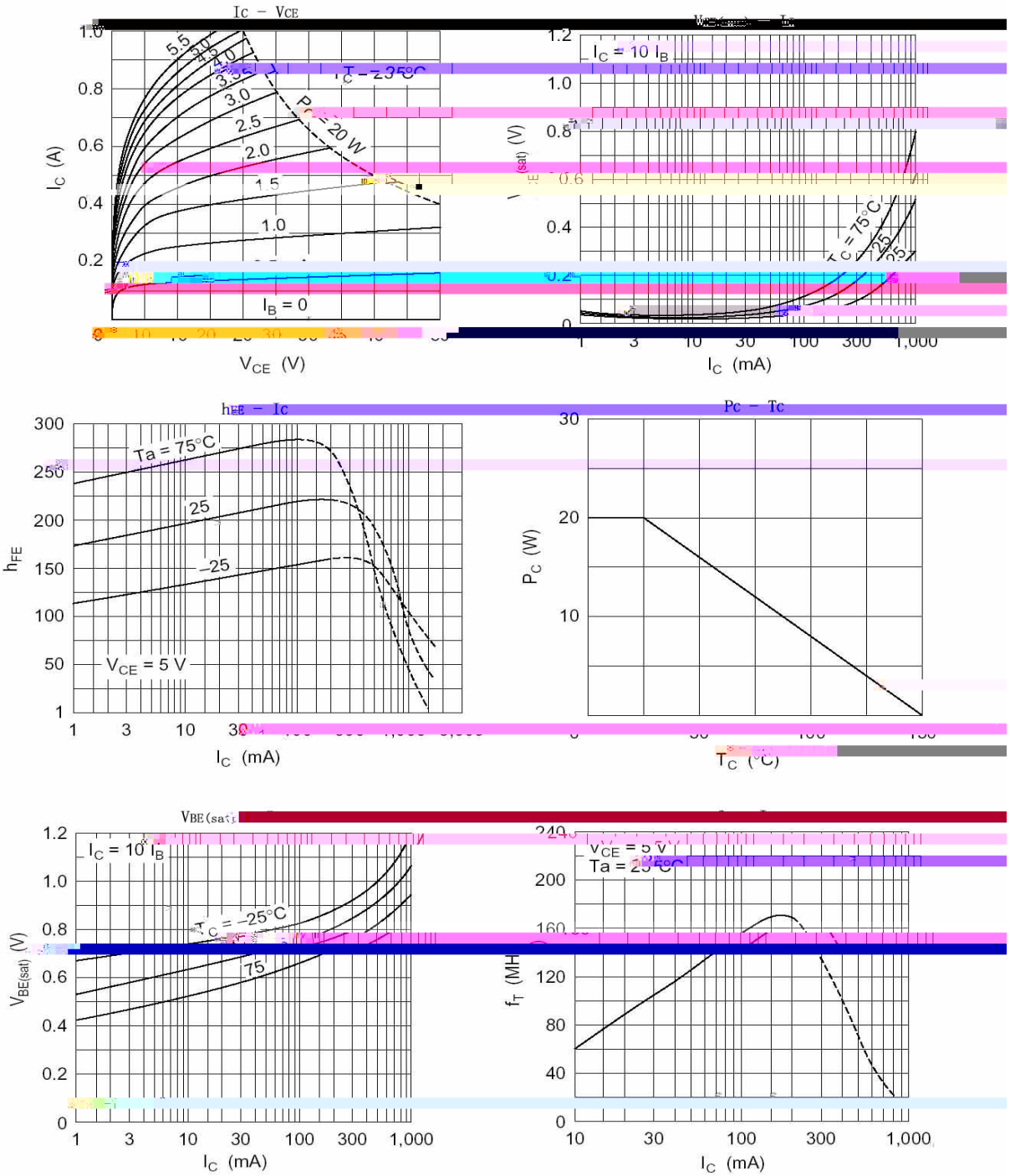
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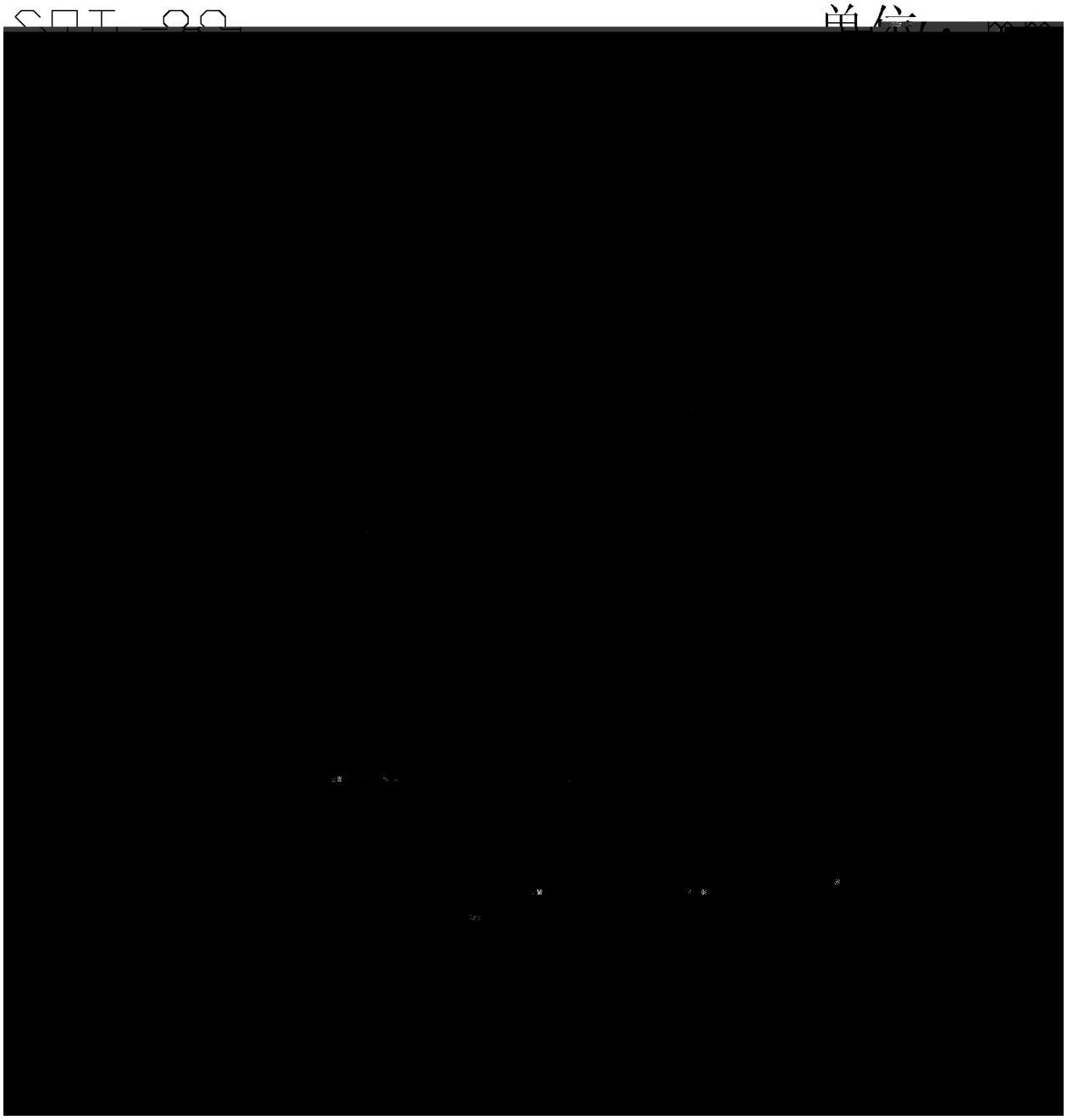
v ˝Ω Parameter	ϒ N Symbol	˝Ω Ö Rating	D Ч Unit
Collector to Base Voltage	V_{CBO}	180	V
Collector to Emitter Voltage	V_{CEO}	160	V
Emitter to Base Voltage	V_{EBO}	5.0	V
Collector Current-Continuous	I_C	1.5	A
Collector Current-Continuous (Pluse)	I_{CP}	3.0	A
Collector Power Dissipation	P_C	500	mW
Collector Power Dissipation	P_C(Tc=25)	20	W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

v ˝Ω Parameter	ϒ N Symbol	Ш :ϯ ϯ Test Conditions	ω ŋ Ö Min	Ɛ ʒ Ö Typ	ω ᶻ Ö Max	D Ч Unit
Collector to Base Breakdown Voltage	V_{CBO}	I_C=1.0mA I_E=0	180			V
Collector to Emitter Breakdown Voltage	V_{CEO}	I_C=10mA R_{BE}=∞	160			V
Emitter to Base Breakdown Voltage	V_{EBO}	I_E=1.0mA I_C=0	5.0			V
Collector Cut-Off Current	I_{CBO}	V_{CB}=160V I_E=0			10	μA
DC Current Gain	$h_{FE(1)}$	V_{CE}=5.0V I_C=150mA	60		320	
	$h_{FE(2)}$	V_{CE}=5.0V I_C=500mA	30			
Base to Emitter Voltage	V_{BE}	V_{CE}=5.0V I_C=150mA			1.5	V
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	I_C=500mA I_B=50mA			1.0	V
Transition Frequency	f_T	V_{CE}=5.0V I_C=150mA		140		MHz-0.0001

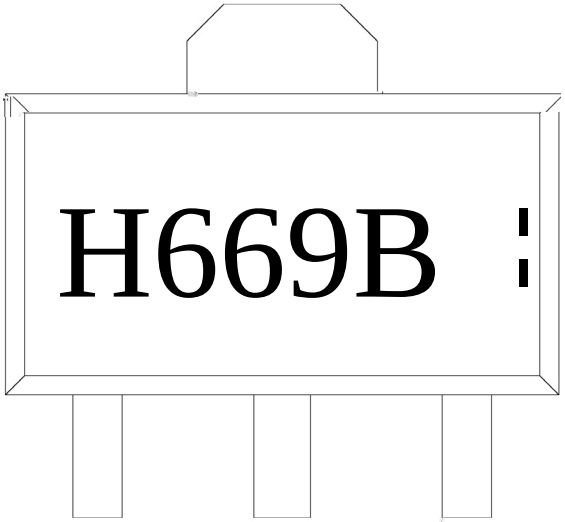
≠ ∃ ЎӒ´Е ∀ ƒ / Electrical Characteristic Curve



ᵘ ĖÒĻ ʃ / Package Dimensions



ł. Ļ"Ω / Marking Instructions



ب ˝ χ

H χ ѭ ҳ и Ґ

669 χ ѭ ҙ N Ґ

B χ ѭ h_{FE} ‘ 6 Ґ

-- χ ѭ ı ғ ӈ̆ N Ґ ı ֆ ı ғ ӈ̆ N Ψ ק

Note:

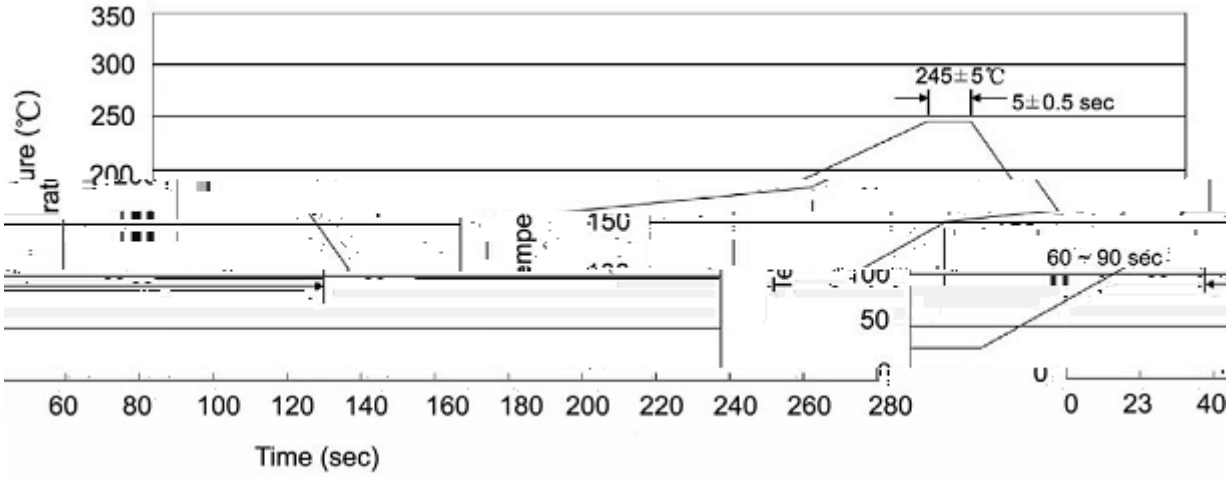
H: Company Code.

669: Product Type.

B χ h_{FE} Classifications Symbol

**: Lot No. Code, code change with Lot No.

ѭ ʃ ╕ ẘ´E ⅵ ƒ (ᾠ ᴈ) / Wh p shudwxuh Suril oh i ru LU Uhi o r z Vr oghulq j +Se0luhh,



ᴗ ˝ χ

1 Ĺ ♬ □ ẙ 25 Ḱ 150 ɬ ı ˋH ᴊ 60 Ḱ 90sec;

2 Š Ë □ ẙ 245 ° 5 ɬ ı ˋH ᴊ ˋY ⅄ ѭ 5 ° 0.5sec;

3 ì ˙ ⅵ ˛ ɔ ѡ ẙ ѭ 2 Ḱ 10 ɬ /sec.

Note:

1.Preheating:25~150 ɬ , Time:60~90sec.

2.Peak Temp.:245 ° 5 ɬ , Duration:5 ° 0.5sec.

3. Cooling Speed: 2~10 ɬ /sec.

⅄ ŭ ɋ ˉ ˋY Ţ / Resistance to Soldering Heat Test Conditions

□ ẙ χ 260 ° 5 ɬ	ˋH ᴊ χ 10 ° 1 sec.	Temp.:260±5	Time:10±1 sec

ɒ Ŀ ≮ — / Packaging SPEC.

ɔ ` ɣ Ŀ / REEL

Package Type	Units					Dimension		(unit mm^3)

ä ⍮ ɭ Ѿ / Notices